

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT5104716

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ARZUM F. SIMSEK-EGE	08/16/2018
GUANGJUN YANG	08/15/2018
KUO-CHEN WANG	07/27/2018
MOHD KAMRAN AKHTAR	08/15/2018
KATSUMI KOGE	07/27/2018
RECEIVING PARTY DATA	
Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
Internal Address:	MAILSTOP 1-507
City:	BOISE
State/Country:	IDAHO
Postal Code:	83707-0006
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16109215
CORRESPONDENCE DATA	
Fax Number:	(801)531-9168
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	801-532-1922
Email:	djpfeil@traskbritt.com
Correspondent Name:	TRASK BRITT, P.C./ MICRON TECHNOLOGY
Address Line 1:	P.O. BOX 2550
Address Line 4:	SALT LAKE CITY, UTAH 84110
ATTORNEY DOCKET NUMBER:	2269-14297(2018-0547.00)
NAME OF SUBMITTER:	JESSE M. FLORES
SIGNATURE:	/Jesse M. Flores/
DATE SIGNED:	08/22/2018
Total Attachments: 6	

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ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, each undersigned ASSIGNOR does hereby:

SELL, ASSIGN AND TRANSFER to MICRON TECHNOLOGY, INC. (“ASSIGNEE”), a Corporation of the State of Delaware, having a place of business at 8000 South Federal Way, Mailstop 1-507, Boise, ID 83707-0006, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements that are disclosed in the **Application for United States Letters Patent** that has been executed by each undersigned ASSIGNOR concurrently herewith, and titled **METHODS OF FORMING SEMICONDUCTOR DEVICES, AND RELATED SEMICONDUCTOR DEVICES, MEMORY DEVICES, AND ELECTRONIC SYSTEMS**, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent or the legal equivalent thereof that have been or may be filed in the United States and all foreign countries relating to any of such improvements; all original, reexamined and reissued patents that have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application made in the United States;

AUTHORIZE the ASSIGNEE to apply for and receive any and all United States and foreign patents relating to such improvements in its own name;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to and in the name of the ASSIGNEE;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement or encumbrance affecting the rights and property herein conveyed has been or will be made or entered into by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, to execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications relating to any and all such improvements; to execute all rightful oaths, declarations, assignments, powers of attorney and other papers; to communicate to the ASSIGNEE all facts and provide to the ASSIGNEE all documents and things known and accessible to the undersigned relating to such improvements and the history thereof, and testify as to the same in any interference, litigation or other proceeding relating thereto; and generally to do everything possible that the ASSIGNEE shall

consider desirable for vesting title to such improvements in the ASSIGNEE, and to secure, maintain, defend and enforce valid and enforceable patent protection for such improvements;

AGREE AND ACKNOWLEDGE that the SALE, ASSIGNMENT AND TRANSFER of rights and property set forth herein is and shall be IRREVOCABLE and BINDING upon the heirs, assigns, representatives and successors of each undersigned ASSIGNOR and EXTEND to the successors, assigns and nominees of the ASSIGNEE.

ASSIGNOR(S):



Arzum F. Simsek-Ege
Residing at: 3320 Heartleaf Drive, Boise, ID 83716

Date: 8/16/2018

Guangjun Yang
Residing at: 2802 S Bay Star Way, Meridian, ID 83642

Date: _____

consider desirable for vesting title to such improvements in the ASSIGNEE, and to secure, maintain, defend and enforce valid and enforceable patent protection for such improvements;

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ASSIGNOR(S):

Arzum F. Simsek-Ege
Residing at: 3320 Heartleaf Drive, Boise, ID 83716

Date: _____



Guangjun Yang
Residing at: 2802 S Bay Star Way, Meridian, ID 83642

Date: 8/15/2018

Kuo-Chen Wang

Date:

27/July/2018

Kuo-Chen Wang

Residing at: c/o Micron Memory Japan, Inc., 8th floor, Shinagawa Season Terrace, Konan, Minato-ku, Tokyo 1-2-70 Japan

Witness:

Signature:

Yoshihiro Yamaya

Date:

2018/7/27

Printed Name: Yoshihiro Yamaya

Address: c/o Micron Memory Japan, Inc.,

8th floor, Shinagawa Season Terrace,

1-2-70, Konan, Minato-ku, Tokyo, Japan 108-0075

Witness:

Signature:

Shoko Tamita

Date:

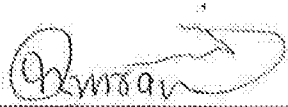
07-27-2018

Printed Name: Shoko Tamita

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1-2-70, Konan, Minato-ku, Tokyo, Japan 108-0075



Date: 3/15/2018

Mohd Kamran Akhtar
Residing at: 6160 East Settlement Court, Boise, ID 83716

Date: _____

Katsumi Koge
Residing at: c/o Micron Memory Japan, Inc., 8th floor, Shinagawa Season Terrace, Konan, Minato-ku, Tokyo 1-2-70 Japan

Witness:

Signature: _____ Date: _____

Printed Name: _____

Address: _____

Witness:

Signature: _____ Date: _____

Printed Name: _____

Address: _____

Date _____

M. Jui Kazumi Kojima
Residing at: 8160 East Settlement Court, Boise, ID 83716

Katsumi Koge

Date: 9 / 27 / 2018

Katsumi Koge
Residing at: c/o Micron Memory Japan, Inc., 8th floor, Shinagawa Season Terrace, Konan, Minato-ku, Tokyo 1-2-70 Japan

Witness:

Signature: Yasuhiro Yamaya

Date: 2018/9/27

Printed Name: Yasuhiro Yamaya

Address: c/o Micron Memory Japan, Inc.,

8th floor, Shinagawa Season Terrace,

1-2-70, Konan, Minato-ku, Tokyo, Japan 108-0075

Witness:

Signature: Shoko Tomita

Date: 09-28-2018

Printed Name: Shoko Tomita

Address: c/o Micron Memory Japan, Inc.,

8th floor, Shinagawa Season Terrace,

1-2-70, Konan, Minato-ku, Tokyo, Japan 108-0075

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